

Supplementary information

Residual Oxygen–Driven P–N Conversion and Thermoelectric Properties in CrN Films

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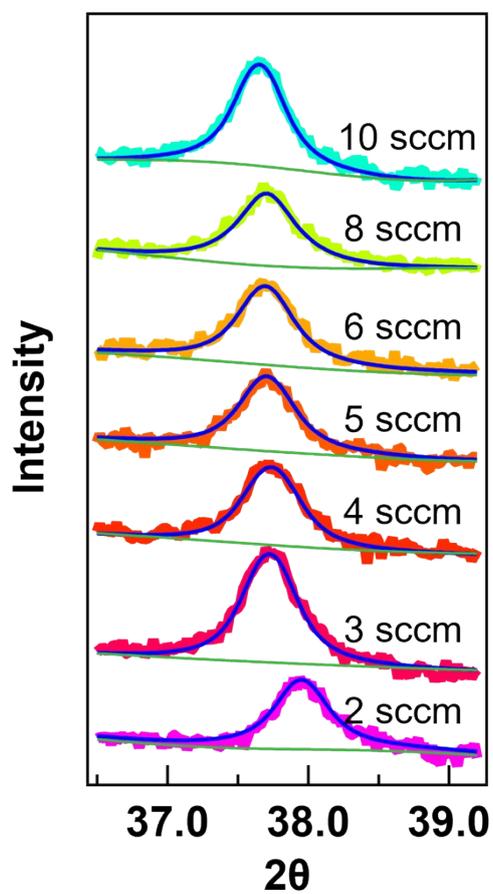


Figure S1. The fitting result of 111 peak of XRD at various N₂ flow rate. For all peaks, the background was fitted using a low-order polynomial function, and the diffraction peaks were fitted using a Voigt function to account for peak broadening mechanisms.

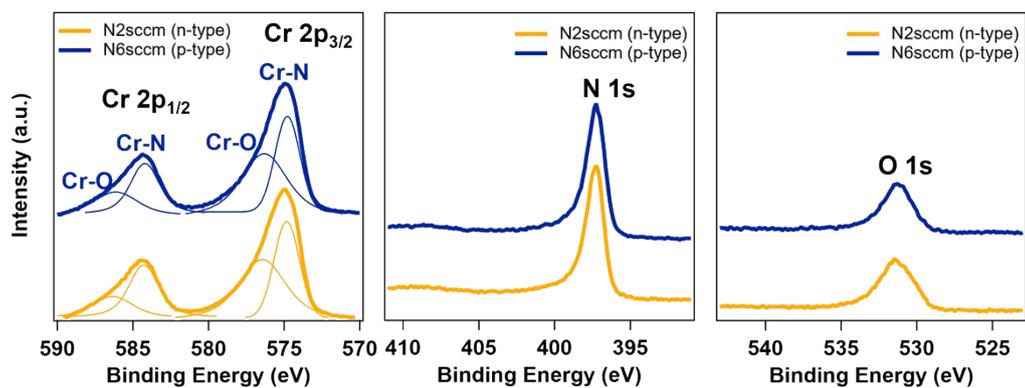


Figure S2. XPS core level spectra for Cr 2p, N 1s, and O 1s. The spectra were taken from the middle of the CrN film to minimize the influence of surface oxidation.

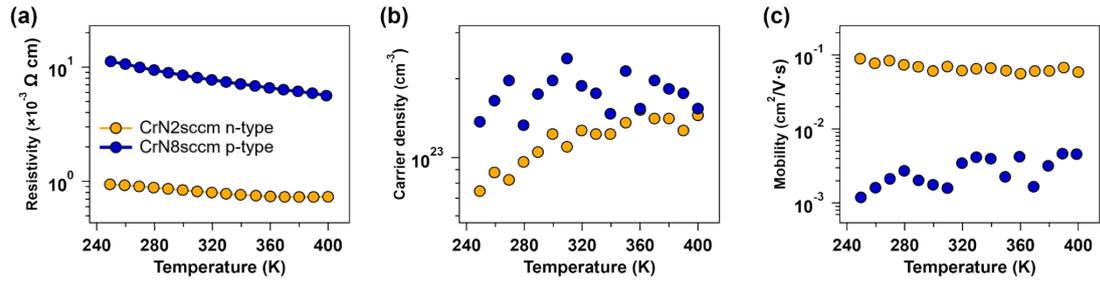


Figure S3. Temperature dependency of (a) resistivity, (b) carrier density and (c) mobility of *n*-type CrN(O) ($f_{\text{N}_2} \sim 2$ sccm, CrN_{0.72}O_{0.11}) and the *p*-type CrN(O) ($f_{\text{N}_2} \sim 8$ sccm, CrN_{0.93}O_{0.27}) films.